# **UWG**

Chip Type, Low Impedance







- Chip type, operating over wide temperature range of to −55 to +105°C.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.
- Compliant to the RoHS directive (2011/65/EU).
- AEC-Q200 compliant. Please contact us for details.

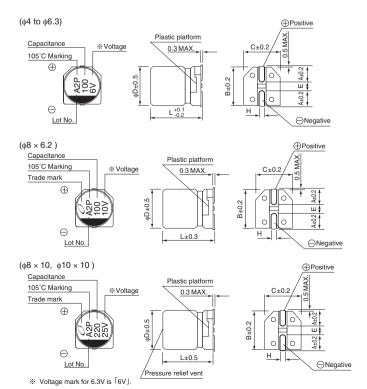




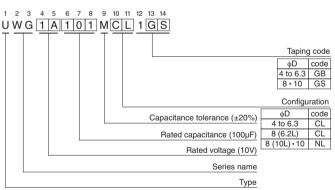
### ■Specifications

Item	Performance Characteristics										
Category Temperature Range	−55 to +105°C										
Rated Voltage Range	6.3 to 50V	3.3 to 50V									
Rated Capacitance Range	1 to 1500μF	to 1500µF									
Capacitance Tolerance	±20% at 120Hz, 20	± 20% at 120Hz, 20°C									
Leakage Current	After 2 minutes' app	After 2 minutes' application of rated voltage at 20°C, leakage current is not more than 0.01CV or 3 (μA), whichever is greater.									
					N	leasuremen	t frequ	ency: 1	20Hz at 20°	С	
Tangent of loss angle (tan δ)	Rated voltage (V)	6.3	10		16	25		35	50		
	tan δ (MAX.)	0.26	0.19		0.16	0.14	0	0.12			
	Measurement frequency: 120Hz										
O. 1. 1111				6.3	10	16	25	35	50		
Stability at Low Temperature	Impedance ratio	Z-25°C/	Z+20°C	2	2	2	2	2	2		
	ZT / Z20 (MAX.)	Z-55°C /	Z+20°C	4	4	3	3	3	3		
	The specifications li		Capacitance change tan δ			Within ±20% of the initial capacitance value					
Endurance	when the capacitors					200% or less than the initial specified value					
	after the rated voltage is applied for 1000 hours at 105°C.							Less than or equal to the initial specified value			
Shelf Life	After storing the capacitors under no load at 105°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.										
	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C. The capacitors shall meet the characteristic						Ca	Capacitance change		Within ±10% of the initial capacitance value	
Resistance to soldering								tan δ		Less than or equal to the initial specified value	
heat	requirements listed at right when they are removed from the plate							Less than or equal to the initial specified value			
Marking	Black print on the ca	ase top.									

### ■Chip Type



### Type numbering system (Example: 10V 100µF)



						(mm)
φD×L	4 × 5.4	5 × 5.4	6.3 × 5.4	8 × 6.2	8 × 10	10 × 10
A	1.8	2.1	2.4	3.3	2.9	3.2
В	4.3	5.3	6.6	8.3	8.3	10.3
С	4.3	5.3	6.6	8.3	8.3	10.3
E	1.0	1.3	2.2	2.3	3.1	4.5
L	5.4	5.4	5.4	6.2	10	10
Н	0.5 to 0.8	0.5 to 0.8	0.5 to 0.8	0.5 to 0.8	0.8 to 1.1	0.8 to 1.1

## **UWG**

#### ■ Dimensions

Can	V 6.3			10		16				
Cap. (µF)	Code	OJ				1A		1C		
10	100			! ! !		 	1	4 × 5.4	3.0	60
22	220	4×5.4	3.0	60		 		5 × 5.4	1.8	95
33	330			i I	5 × 5.4	1.8	95			i
47	470	5×5.4	1.8	95				6.3 × 5.4	1.0	140
68	680	6.3×5.4	1.0	140		 	1	8 × 6.2	0.4	230
100	101	6.3×5.4	1.0	140	8×6.2	0.4	230	8 × 6.2	0.4	230
150	151			 	8 × 6.2	0.4	230			
220	221	8×6.2	0.4	230	8×10	0.3	450	10 × 10	0.15	670
330	331	8×10	0.3	450			İ	10 × 10	0.15	670
470	471			 	10×10	0.15	670	10 × 10	0.15	670
680	681			 		I I		10 × 10	0.15	670
1000	102	10×10	0.15	670	10 × 10	0.15	670			
1500	152	10×10	0.15	670						

Can			25			35		50		
Cap. (µF)	Code	1E				1V		1H		
1	010		 	! ! !	4 × 5.4	3.0	60	4 × 5.4	5.0	30
2.2	2R2		 	 	4 × 5.4	3.0	60	4 × 5.4	5.0	30
3.3	3R3		i I	i I	4 × 5.4	3.0	60	4 × 5.4	5.0	30
4.7	4R7		I I	! !	4 × 5.4	3.0	60	5 × 5.4	3.0	50
6.8	6R8	4 × 5.4	3.0	60	5×5.4	1.8	95			
10	100			i !	5×5.4	1.8	95	6.3 × 5.4	2.0	70
22	220	6.3 × 5.4	1.0	140	6.3 × 5.4	1.0	140	8 × 6.2	0.7	120
33	330	6.3 × 5.4	1.0	140	8 × 6.2	0.4	230	8 × 10	0.6	300
47	470	8 × 6.2	0.4	230	8 × 6.2	0.4	230	10 × 10	0.3	500
68	680	8×10	0.3	450		 	 			
100	101	8×10	0.3	450	10×10	0.15	670	10 × 10	0.3	500
220	221	10×10	0.15	670	10×10	0.15	670	10 × 10	0.3	500
330	331	10×10	0.15	670	10×10	0.15	670	Case size	Impedance	Rated ripple
470	471	10×10	0.15	670				$\phi D \times L (mm)$		

Max. Impedance  $\,(\Omega)$  at 20°C 100kHz Rated ripple current (mArms) at 105°C 100kHz

### • Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Coefficient	0.35	0.50	0.64	0.83	1.00

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please select UUJ(p.164) if high C/V products are reqired.
- Please refer to page 3 for the minimum order quantity.

### **Mouser Electronics**

**Authorized Distributor** 

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### Nichicon:

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UWG1V101MNL1GS UWF1V6R8MCL1GB UWG0J220MCL1GB UWG0J470MCL1GB UWG0J680MCL1GB
UWG0J101MCL1GB UWG0J221MCL1GS UWG0J331MNL1GS UWG0J102MNL1GS UWG0J152MNL1GS
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